

## isc N-Channel MOSFET Transistor

1N65

## • FEATURES

- Drain Current  $I_D = 1.2A @ T_C=25^\circ C$
- Drain Source Voltage :  $V_{DSS} = 650V$ (Min)
- Static Drain-Source On-Resistance :  $R_{DS(on)} = 12.5 \Omega$  (Max)
- Fast Switching

## • APPLICATIONS

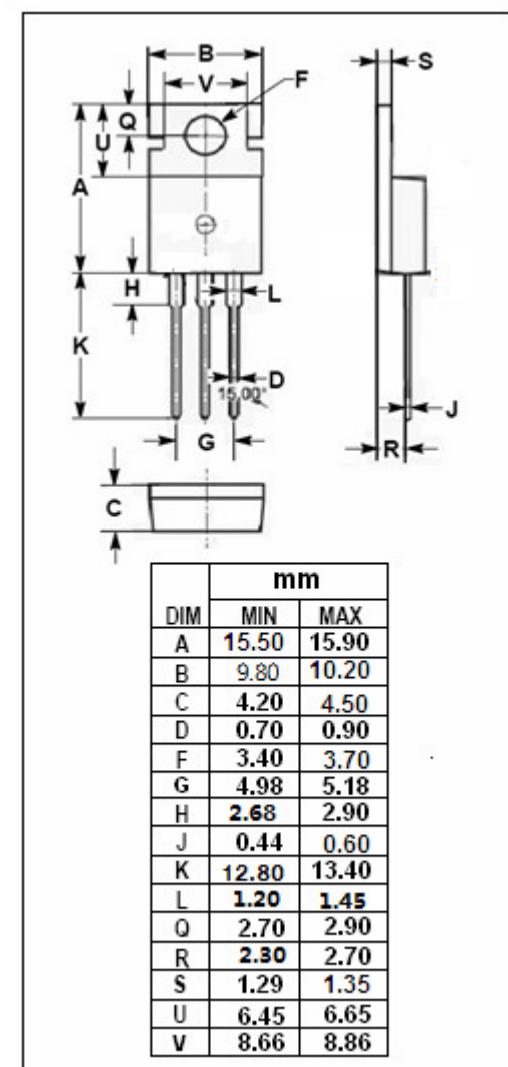
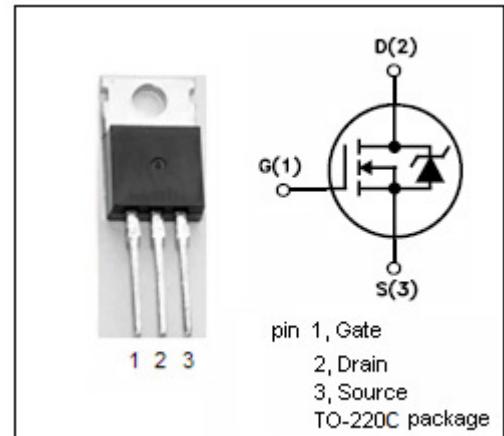
- Switching power supplies, converters, AC and DC motor controls

• ABSOLUTE MAXIMUM RATINGS( $T_a=25^\circ C$ )

SYMBOL	PARAMETER	VALUE	UNIT
$V_{DSS}$	Drain-Source Voltage	650	V
$V_{GS}$	Gate-Source Voltage-Continuous	$\pm 30$	V
$I_D$	Drain Current-Continuous	1.2	A
$I_{DM}$	Drain Current-Single Plused	4.8	A
$P_D$	Total Dissipation @ $T_C=25^\circ C$	40	W
$T_j$	Max. Operating Junction Temperature	150	°C
$T_{stg}$	Storage Temperature	-55~150	°C

## • THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th j-c}$	Thermal Resistance, Junction to Case	3.13	°C/W
$R_{th j-a}$	Thermal Resistance, Junction to Ambient	62.5	°C/W



**isc N-Channel MOSFET Transistor****1N65****• ELECTRICAL CHARACTERISTICS****T<sub>c</sub>=25°C unless otherwise specified**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0; I <sub>D</sub> =250μA	650			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> ; I <sub>D</sub> =250μA	2.0		4.0	V
V <sub>SD</sub>	Diode Forward On-voltage	I <sub>S</sub> = 1.2A; V <sub>GS</sub> = 0			1.4	V
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> = 10V; I <sub>D</sub> = 0.6A			12.5	Ω
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ±30V; V <sub>DS</sub> = 0			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =650V; V <sub>GS</sub> = 0			10	μA

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